

STN	Technológia povrchovej montáže Časť 2: Požiadavky na prepravu a skladovanie súčiastok na povrchovú montáž (SMD) Pokyny na použitie	STN EN IEC 61760-2 35 9310
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Surface mounting technology - Part 2: Transportation and storage conditions of surface mounting devices (SMD) - Application guide

Táto norma obsahuje anglickú verziu európskej normy.
This standard includes the English version of the European Standard.

Táto norma bola oznámená vo Vestníku ÚNMS SR č. 11/21

Obsahuje: EN IEC 61760-2:2021, IEC 61760-2:2021

Oznámením tejto normy sa od 20.08.2024 ruší
STN EN 61760-2 (35 9310) z februára 2008

EUROPEAN STANDARD

EN IEC 61760-2

NORME EUROPÉENNE

EUROPÄISCHE NORM

September 2021

ICS 31.240

Supersedes EN 61760-2:2007 and all of its amendments
and corrigenda (if any)

English Version

Surface mounting technology - Part 2: Transportation and
storage conditions of surface mounting devices (SMD) -
Application guide
(IEC 61760-2:2021)

Technique du montage en surface - Partie 2: Conditions de
transport et de stockage des composants pour montage en
surface (CMS) - Guide d'application
(IEC 61760-2:2021)

Oberflächenmontagetechnik - Teil 2: Transport- und
Lagerungsbedingungen von oberflächenmontierbaren
Bauelementen (SMD) - Anwendungsleitfaden
(IEC 61760-2:2021)

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Europäisches Komitee für Elektrotechnische Normung

CEN-CENELEC Management Centre: Rue de la Science 23, B-1040 Brussels

EN IEC 61760-2:2021 (E)**European foreword**

The text of document 91/1666/CDV, future edition 3 of IEC 61760-2, prepared by IEC/TC 91 “Electronics assembly technology” was submitted to the IEC-CENELEC parallel vote and approved by CENELEC as EN IEC 61760-2:2021.

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IEC 60286-3	NOTE Harmonized as EN IEC 60286-3
IEC 60286-4	NOTE Harmonized as EN 60286-4
IEC 60286-5	NOTE Harmonized as EN IEC 60286-5
IEC 60286-6	NOTE Harmonized as EN 60286-6
IEC 60749 (series)	NOTE Harmonized as EN 60749 (series)
IEC 60749-20-1:2019	NOTE Harmonized as EN IEC 60749-20-1:— ¹ (not modified)
IEC 61340-5-1	NOTE Harmonized as EN 61340-5-1
IEC 61760-4:2015	NOTE Harmonized as EN 61760-4:2015 (not modified)
IEC 62435 (series)	NOTE Harmonized as EN IEC 62435 (series)

¹ To be published. Stage at the time of publication: prEN IEC 60749-20-1:2019.

Annex ZA (normative)

Normative references to international publications with their corresponding European publications

The following documents are referred to in the text in such a way that some or all of their content constitutes requirements of this document. For dated references, only the edition cited applies. For undated references, the latest edition of the referenced document (including any amendments) applies.

NOTE 1 Where an International Publication has been modified by common modifications, indicated by (mod), the relevant EN/HD applies.

NOTE 2 Up-to-date information on the latest versions of the European Standards listed in this annex is available here: www.cenelec.eu.

<u>Publication</u>	<u>Year</u>	<u>Title</u>	<u>EN/HD</u>	<u>Year</u>
IEC 60721-3-1	2018	Classification of environmental conditions -EN IEC 60721-3-1 Part 3–1: Classification of groups of environmental parameters and their severities - Storage	EN IEC 60721-3-1	2018
IEC 60721-3-2	2018	Classification of environmental conditions -EN IEC 60721-3-2 Part 3–2: Classification of groups of environmental parameters and their severities - Transportation and handling	EN IEC 60721-3-2	2018



IEC 61760-2

Edition 3.0 2021-07

INTERNATIONAL STANDARD

NORME INTERNATIONALE



**Surface mounting technology –
Part 2: Transportation and storage conditions of surface mounting devices
(SMD) – Application guide**

**Technique du montage en surface –
Partie 2: Conditions de transport et de stockage des composants pour montage
en surface (CMS) – Guide d'application**



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IEC 61760-2

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INTERNATIONAL STANDARD

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ICS 31.240

ISBN 978-2-8322-1002-8

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INTERNATIONAL ELECTROTECHNICAL COMMISSION

SURFACE MOUNTING TECHNOLOGY –**Part 2: Transportation and storage conditions
of surface mounting devices (SMD) –
Application guide**

FOREWORD

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The text of this International Standard is based on the following documents:

Draft	Report on voting
91/1666/CDV	91/1708/RVC

Full information on the voting for its approval can be found in the report on voting indicated in the above table.

The language used for the development of this International Standard is English.

This document was drafted in accordance with ISO/IEC Directives, Part 2, and developed in accordance with ISO/IEC Directives, Part 1 and ISO/IEC Directives, IEC Supplement, available

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Cross-references for references from this edition 3 to the previous edition 2 of this document are listed in Annex X of this document.

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SURFACE MOUNTING TECHNOLOGY –

Part 2: Transportation and storage conditions of surface mounting devices (SMD) – Application guide

1 Scope

This International Standard specifies the transportation and storage conditions for surface mounting devices (SMDs) that are fulfilled in order to enable trouble-free processing of surface mounting devices, both active and passive. (Conditions for printed boards are not taken into consideration.)

The object of this document is to ensure that users of SMDs receive and store products that can be further processed (e.g. positioned, soldered) without prejudice to quality and reliability. Improper transportation and storage of SMDs can cause deterioration and result in assembly problems such as poor solderability, delamination and "popcorning".

2 Normative references

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IEC 60721-3-1:2018, *Classification of environmental conditions – Part 3-1: Classification of groups of environmental parameters and their severities – Storage*

IEC 60721-3-2:2018, *Classification of environmental conditions – Part 3-2: Classification of groups of environmental parameters and their severities – Transportation and handling*

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